Declaration and Power of Attorney For Patent Application English Languag D claration

As a below named inv	entor, I hereby decla	re that:					
My residence, post offic address and citizenship are as stated below next to my name,							
I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled <u>SLAB WAVEGUIDE AND METHOD OF MANUFACTURING THE SLAB WAVEGUIDE</u> , the specification of which is attached hereto unless the following box is checked:							
was filed on	as						
United States Application Number or PCT International Application Number and was amended on August 27, 2003 by Preliminary Amenament (if applicable).							
I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above:							
I acknowledge the dut 1.56.	y to disclose informa	ation which is material to patentability as defined in 37 CFR §					
I hereby claim foreign priority benefits under 35 U.S.C. §119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT International application which designated at least one country other than the United States, listed below and have also identified below by checking the box, any foreign application for patent or inventor's certificate, or PCT International application having a filing date beauty that of the application on which priority is claimed:							
Prior Foreign Applicati 2002-249691	ion(s) Japan	Priority Not Claim d					
(Number)	(Country)	(Day/Month/Year Filed)					
 (Number)	(Country)	(Day/Month/Year Filed)					
I hereby claim the be listed below.	enefit under 35 U.S.	C. § 119(e) of any United States provisional application(s)					
(Application Number)	(Filing Date)						
(Application Number)	(Filing Date)						
PCT International app matter of each of the International applicati acknowledge the duty	olication designating e claims of this app on in the manner to disclose informat vailable between the	. § 120 of any United States application(s), or 365(c) of any the United States, listed below and, insofar as the subject lication is not disclosed in the prior United States or PCT provided by the first paragraph of 35 U.S.C. § 112, I ion which is material to patentability as defined in 37 CFR § a filing date of the prior application and the national or PCT					

(Application Number)		(Filing Date)	(Status - pater	nted, pending, abando	ng, abandoned)		
(Application Number)		(Filing Date)	(Status - pater	(Status - patented, pending, abandoned)			
	ecute this app	a named inventor, lication and transact					
Robert L. Andersen Danlel N. Calder Joshua L. Cohen Kevin W. Goldstein Costas S. Krikelis Bruce M. Monroe Kenneth N. Nigon Allan Ratner Jonathan H. Spadt	Reg. No. 25,771 Reg. No. 27,424 Reg. No. 38,040 Reg. No. 34,608 Reg. No. 28,028 Reg. No. 33,602 Reg. No. 31,549 Reg. No. 19,717 Reg. No. 45,122	Lawrence E. Ashery Lowell L. Carson Rex A. Donnelly, IV William P. Hauser Benjamin E. Leace Andrew L. Ney Pamela D. Politis Robert P. Seitter Christopher M. Spletzer	Reg. No. 34,515 Reg. No. 48,548 Reg. No. 41,712 Reg. No. 26,277 Reg. No. 33,412 Reg. No. 20,300 Reg. No. 47,865 Reg. No. 24,856 Reg. No. 52,240	Steven E. Bach Kevin R. Casey Jacques L. Etkowicz Jack J. Jankovitz Christopher R. Lewis Paul F. Prestia James C. Simmons Frank Tise Stanley Weinberg	Reg. No. 42,690		
Address all correspondence to:							
statements made were made with t by fine or impriso such willful false	e on informatio the knowledge onment, or bot statements ma	tatements made he on and belief are belie that willful false s th, under Section 100 by jeopardize the valid	eved to be true; statements and 01 of Title 18 or dity of the applica	and further that the like so mad f the United State	these statements de are punishable es Code and that		
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Full name of second joint inventor, if any (given name, family name)							
Second Inventor's sign	nature			Date			
Citizenship							
Post Office Address							
_							
Additional inventors are being named on separately numbered sheets attached hereto.							